Low-power configurable gate with voltage-level translatorRev. 01 — 6 March 2008Product data set

Product data sheet

1. **General description**

The 74AUP1T98 provides low-power, low-voltage configurable logic gate functions. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions MUX, AND, OR, NAND, NOR, inverter and buffer. All inputs can be connected to V_{CC} or GND.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 2.3 V to 3.6 V.

The 74AUP1T98 is designed for logic-level translation applications with input switching levels that accept 1.8 V low-voltage CMOS signals, while operating from either a single 2.5 V or 3.3 V supply voltage.

The wide supply voltage range ensures normal operation as battery voltage drops from 3.6 V to 2.3 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Schmitt trigger inputs make the circuit tolerant to slower input rise and fall times across the entire V_{CC} range.

Features 2.

- Wide supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- ESD protection:
 - HBM JESD22-A114E Class 3A exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Low static power consumption; $I_{CC} = 1.5 \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C



Low-power configurable gate with voltage-level translator

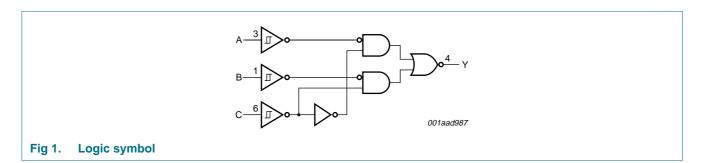
3. Ordering information

Table 1. Ordering	g information									
Type number	Package	Package								
	Temperature range	Name	Description	Version						
74AUP1T98GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363						
74AUP1T98GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886						
74AUP1T98GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm	SOT891						

4. Marking

Table 2. Marking	
Type number	Marking code
74AUP1T98GW	aR
74AUP1T98GM	aR
74AUP1T98GF	aR

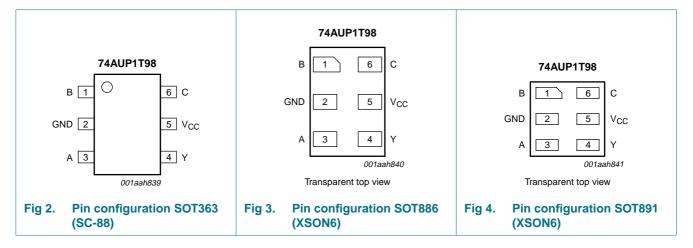
5. Functional diagram



Low-power configurable gate with voltage-level translator

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
В	1	data input
GND	2	ground (0 V)
A	3	data input
Y	4	data output
V _{CC}	5	supply voltage
С	6	data input

7. Functional description

Table 4. Function table^[1] Input Output С в Υ Α Н L L L Н L L Н L Н L L L Н Н L Н Н L L L Н L Н Н Н Н L Н Н Н L

[1] H = HIGH voltage level;

L = LOW voltage level.

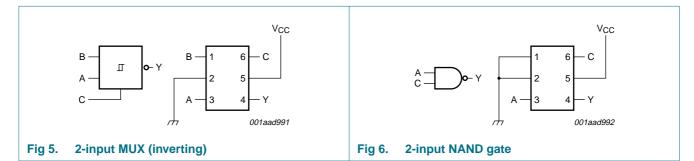
74AUP1T98

Low-power configurable gate with voltage-level translator

7.1 Logic configurations

Table 5. Function selection table

Logic function	Figure
2-input MUX (inverting)	see Figure 5
2-input NAND	see Figure 6
2-input NOR with one input inverted	see Figure 7
2-input AND with one input inverted	see Figure 7
2-input NAND with one input inverted	see Figure 8
2-input OR with one input inverted	see Figure 8
2-input NOR	see Figure 9
Buffer	see Figure 10
Inverter	see Figure 11



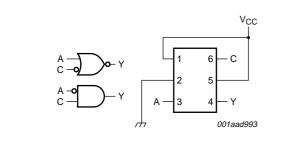


Fig 7. 2-input AND gate with input A inverted or 2-input NOR gate with input C inverted

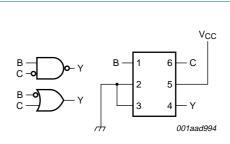
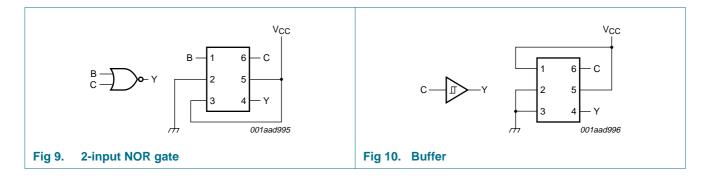
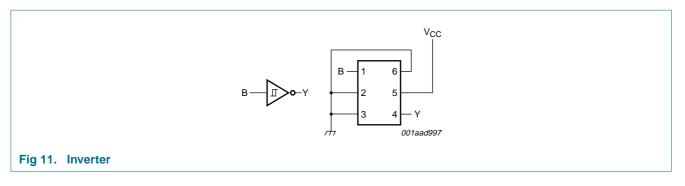


Fig 8. 2-input OR gate with input B inverted or 2-input NAND gate with input C inverted



Low-power configurable gate with voltage-level translator



8. Limiting values

Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	$V_{l} < 0 V$	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±20	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 7. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		2.3	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C

Low-power configurable gate with voltage-level translator

10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	25 °C					
V _{T+}	positive-going threshold	V_{CC} = 2.3 V to 2.7 V	0.60	-	1.10	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.75	-	1.16	V
V _{T-}	negative-going threshold	V_{CC} = 2.3 V to 2.7 V	0.35	-	0.60	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.50	-	0.85	V
V _H	hysteresis voltage	$(V_H=V_{T+}-V_{T-})$				
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	0.23	-	0.60	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.25	-	0.56	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		I_{O} = -20 μ A; V_{CC} = 2.3 V to 3.6 V	$V_{CC} - 0.1$	-	-	V
		$I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7$ mA; $V_{CC} = 3.0$ V	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		I_{O} = 20 μ A; V_{CC} = 2.3 V to 3.6 V	-	-	0.10	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
l _l	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μA
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.1	μA
ΔI_{OFF}	additional power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.2	μA
I _{CC}	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$	-	-	1.2	μA
Cı	input capacitance	V_{CC} = 0 V to 3.6 V; V_{I} = GND or V_{CC}	-	0.8	-	pF
Co	output capacitance	$V_O = GND; V_{CC} = 0 V$	-	1.7	-	pF
T _{amb} = –	40 °C to +85 °C					
V _{T+}	positive-going threshold	V_{CC} = 2.3 V to 2.7 V	0.60	-	1.10	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.75	-	1.19	V
V _{T-}	negative-going threshold	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.35	-	0.60	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.50	-	0.85	V
V _H	hysteresis voltage	$(V_{H} = V_{T+} - V_{T-})$				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.10	-	0.60	V
		V _{CC} = 3.0 V to 3.6 V	0.15	-	0.56	V

74AUP1T98

Low-power configurable gate with voltage-level translator

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Parameter	Conditions	Min	Тур	Max	Unit
HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	I_{O} = –20 $\mu A;$ V_{CC} = 2.3 V to 3.6 V	$V_{CC} - 0.1$	-	-	V
	$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
	$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
	$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
	$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	$I_0 = 20 \ \mu A; \ V_{CC} = 2.3 \ V \ to \ 3.6 \ V$	-	-	0.1	V
	$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
	I _O = 3.1 mA; V _{CC} = 2.3 V	-	-	0.45	V
	$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
	I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.45	V
input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μΑ
power-off leakage current	V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.5	μA
additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.5	μA
supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \; A; \\ V_{CC} = 2.3 \; V \; to \; 3.6 \; V \end{array}$	-	-	1.5	μΑ
additional supply current	V_{CC} = 2.3 V to 2.7 V; I_O = 0 A	<u>[1]</u> -	-	4	μA
	V_{CC} = 3.0 V to 3.6 V; I_{O} = 0 A	[2] _	-	12	μA
40 °C to +125 °C					
positive-going threshold	V_{CC} = 2.3 V to 2.7 V	0.60	-	1.10	V
voltage	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.75	-	1.19	V
negative-going threshold	V_{CC} = 2.3 V to 2.7 V	0.33	-	0.64	V
voltage	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.46	-	0.85	V
hysteresis voltage	$(V_H = V_T+ - V_T-)$				
	V_{CC} = 2.3 V to 2.7 V	0.10	-	0.60	V
	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.15	-	0.56	V
HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	I_{O} = -20 μ A; V_{CC} = 2.3 V to 3.6 V	V _{CC} – 0.11	-	-	V
	$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	V
	$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
	$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
	$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V
LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{II}$				
		-	-	0.11	V
		-	-	0.36	V
		-	-	0.50	V
	$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
	0 , 00				
	$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V
	HIGH-level output voltage LOW-level output voltage input leakage current power-off leakage current additional power-off leakage current supply current additional supply current additional supply current to °C to +125 °C positive-going threshold voltage hysteresis voltage HIGH-level output voltage	$\begin{split} \text{HIGH-level output voltage} & \frac{V_1 = V_{1L} \text{ or } V_{1L}}{I_0 = -20\mu\text{A};V_{CC} = 2.3Vto3.6V} \\ I_0 = -3.1\text{mA};V_{CC} = 2.3Vto3.6V} \\ I_0 = -3.1\text{mA};V_{CC} = 2.3Vto3.6V} \\ I_0 = -2.7\text{mA};V_{CC} = 3.0V \\ I_0 = -4.0\text{mA};V_{CC} = 3.0V \\ I_0 = -4.0\text{mA};V_{CC} = 2.3Vto3.6V \\ I_0 = 20\mu\text{A};V_{CC} = 2.3Vto3.6V \\ I_0 = 2.3\text{mA};V_{CC} = 2.3Vto3.6V \\ I_0 = 2.3\text{mA};V_{CC} = 2.3Vto3.6V \\ I_0 = 2.7\text{mA};V_{CC} = 2.3Vto3.6V \\ I_0 = 2.3\text{mA};V_{CC} = 2.3Vto3.6V \\ I_0 = 2.7\text{mA};V_{CC} = 3.0V \\ I_0 = 4.0\text{mA};V_{CC} = 0Vto3.6V \\ V_{CC} = 2.3Vto3.6V \\ V_{CC} = 0Vto3.6V;V_{CC} = 0V \\ additional power-off leakage current V_{1C} V_0 = 0Vto3.6V;V_{CC} = 0V \\ additional power-off leakage current V_{CC} = 0Vto3.6V \\ V_{CC} = 2.3Vto3.6V \\ V_{CC} = 3.0Vto3.6V \\ V_{CC} = 2.3Vto3.6V \\ V_{CC$	$ \begin{tabular}{lllllllllllllllllllllllllllllllllll$	$\begin{tabular}{l leakage current} $V_1 = V_{1H} \mbox{ or } V_{1C}$ = 2.3 \mbox{ v} to 3.6 \mbox{ v} V_{CC}$ = 0.1 \mbox{ 1.97 } $-1$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$	$ \begin{array}{llllllllllllllllllllllllllllllllllll$

Low-power configurable gate with voltage-level translator

At recom	mended operating conditions	s; voltages are referenced to GND (grou	und = 0 V).			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	±0.75	μΑ
ΔI_{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.75	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 2.3 \ V \ \text{to} \ 3.6 \ V \end{array}$	-	-	3.5	μA
ΔI_{CC}	additional supply current	V_{CC} = 2.3 V to 2.7 V; I_{O} = 0 A	<u>[1]</u> _	-	7	μA
		V_{CC} = 3.0 V to 3.6 V; I_O = 0 A	[2] _	-	22	μA

Table 8. Static characteristics ... continued

[1] One input at 0.3 V or 1.1 V, other input at V_{CC} or GND.

[2] One input at 0.45 V or 1.2 V, other input at V_{CC} or GND.

11. Dynamic characteristics

Dynamic characteristics Table 9.

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

Symbol	Parameter	Conditions			25 °C		-4	0 °C to +1	25 °C	Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
V _{CC} = 2.	3 V to 2.7 V; V _I = 1.6	65 V to 1.95 V								
t _{pd}	propagation delay	A, B, C to Y; see Figure 12	[2]							
		C _L = 5 pF		2.0	3.6	5.7	0.5	6.8	7.5	ns
		C _L = 10 pF		2.5	4.2	6.3	1.0	7.9	8.7	ns
		C _L = 15 pF		2.9	4.6	6.9	1.0	8.7	9.6	ns
		C _L = 30 pF		3.9	5.8	8.3	1.5	10.8	11.9	ns
V _{CC} = 2.	3 V to 2.7 V; V _I = 2.3	3 V to 2.7 V								
t _{pd}	propagation delay	A, B, C to Y; see Figure 12	[2]							
		C _L = 5 pF		1.7	3.4	5.6	0.5	6.0	6.6	ns
		C _L = 10 pF		2.1	4.0	6.3	1.0	7.1	7.9	ns
		C _L = 15 pF		2.5	4.5	6.9	1.0	7.9	8.7	ns
		C _L = 30 pF		3.4	5.6	8.4	1.5	10.0	11.0	ns
V _{CC} = 2.	3 V to 2.7 V; V _I = 3.0) V to 3.6 V								
t _{pd}	propagation delay	A, B, C to Y; see Figure 12	[2]							
		$C_L = 5 \text{ pF}$		1.3	3.2	5.2	0.5	5.5	6.1	ns
		C _L = 10 pF		1.8	3.7	5.9	1.0	6.5	7.2	ns
		C _L = 15 pF		2.2	4.2	6.5	1.0	7.4	8.2	ns
		C _L = 30 pF		3.1	5.4	7.9	1.5	9.5	10.5	ns
V _{CC} = 3.	0 V to 3.6 V; V _I = 1.6	65 V to 1.95 V								
t _{pd}	propagation delay	A, B, C to Y; see Figure 12	[2]							
		C _L = 5 pF		2.0	2.9	4.1	0.5	8.0	8.8	ns
		C _L = 10 pF		2.4	3.5	4.8	1.0	8.5	9.4	ns
		C _L = 15 pF		2.8	3.9	5.4	1.0	9.1	10.1	ns
		C _L = 30 pF		3.6	5.1	6.9	1.5	9.8	10.8	ns

74AUP1T98_1

Low-power configurable gate with voltage-level translator

Symbol	Parameter	Conditions		25 °C		-4	0 °C to +1	25 °C	Unit
				Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
V _{CC} = 3.	0 V to 3.6 V; V _I = 2.3	3 V to 2.7 V							
t _{pd}	propagation delay	A, B, C to Y; see Figure 12 [2]							
		C _L = 5 pF	1.5	2.8	4.4	0.5	5.3	5.9	ns
		C _L = 10 pF	2.0	3.4	5.1	1.0	6.1	6.8	ns
		C _L = 15 pF	2.4	3.9	5.7	1.0	6.8	7.5	ns
		C _L = 30 pF	3.4	5.0	7.2	1.5	8.5	9.4	ns
V _{CC} = 3.	0 V to 3.6 V; V _I = 3.0) V to 3.6 V							
t _{pd}	propagation delay	A, B, C to Y; see Figure 12 [2]							
		C _L = 5 pF	1.3	2.8	4.4	0.5	4.7	5.2	ns
		C _L = 10 pF	1.7	3.3	5.2	1.0	5.7	6.3	ns
		C _L = 15 pF	2.1	3.8	5.8	1.0	6.2	6.9	ns
		C _L = 30 pF	3.1	5.0	7.2	1.5	7.8	8.6	ns
T _{amb} = 2	25 °C								
C _{PD}	power dissipation	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{\text{CC}}$ [3]							
	capacitance	V_{CC} = 2.3 V to 2.7 V	-	3.6	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V	-	4.3	-	-	-	-	pF

Table 9. Dynamic characteristics ... continued

[1] All typical values are measured at nominal V_{CC}.

[2] t_{pd} is the same as t_{PLH} and t_{PHL}

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 f_0 = output frequency in MHz;

 C_{L} = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

Low-power configurable gate with voltage-level translator

12. Waveforms

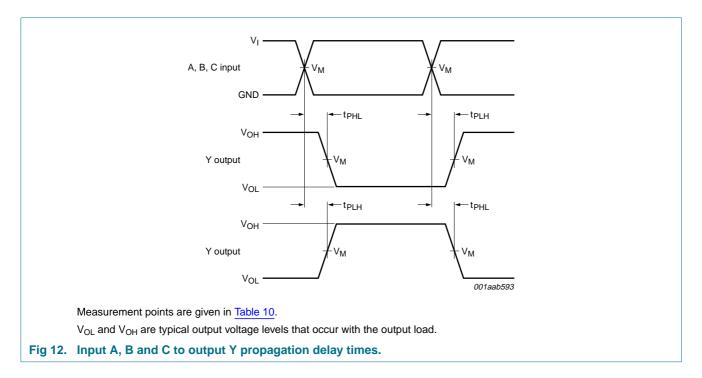


Table 10. Measurement points

Supply voltage	Output	Input					
V _{CC}	V _M	V _M	VI	$t_r = t_f$			
2.3 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{I}$	1.65 V to 3.6 V	≤ 3.0 ns			

Low-power configurable gate with voltage-level translator

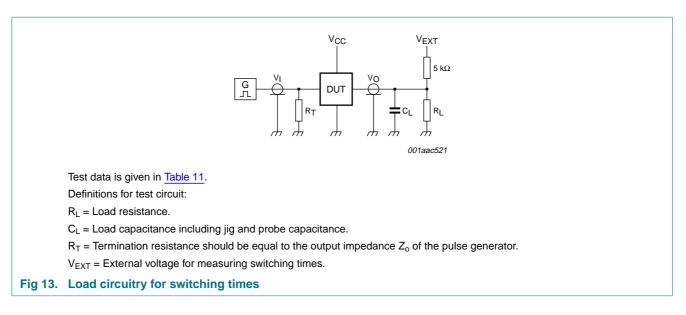


Table 11. Test data

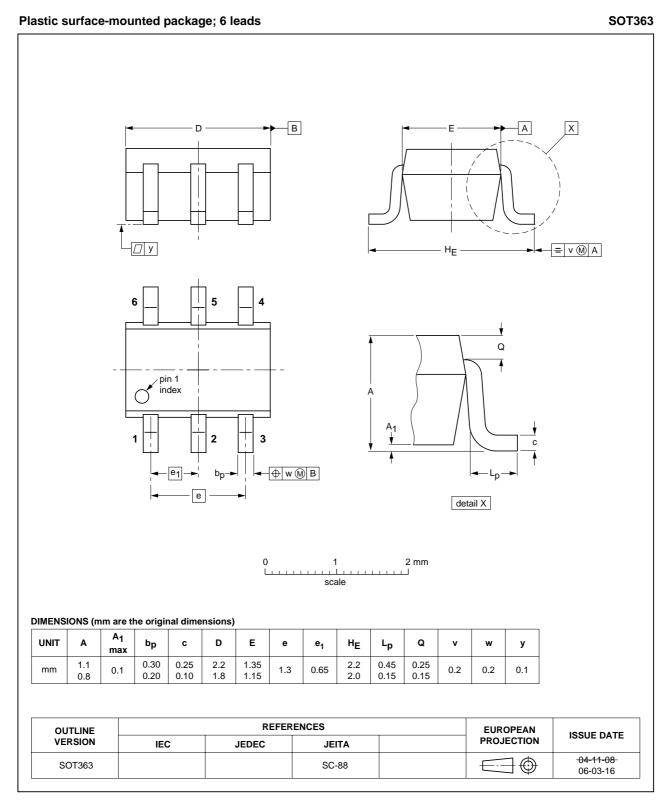
Supply voltage	Load		V _{EXT}		
V _{cc}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
2.3 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times $R_L = 5 k\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 M\Omega$.

74AUP1T98

Low-power configurable gate with voltage-level translator

13. Package outline



Low-power configurable gate with voltage-level translator

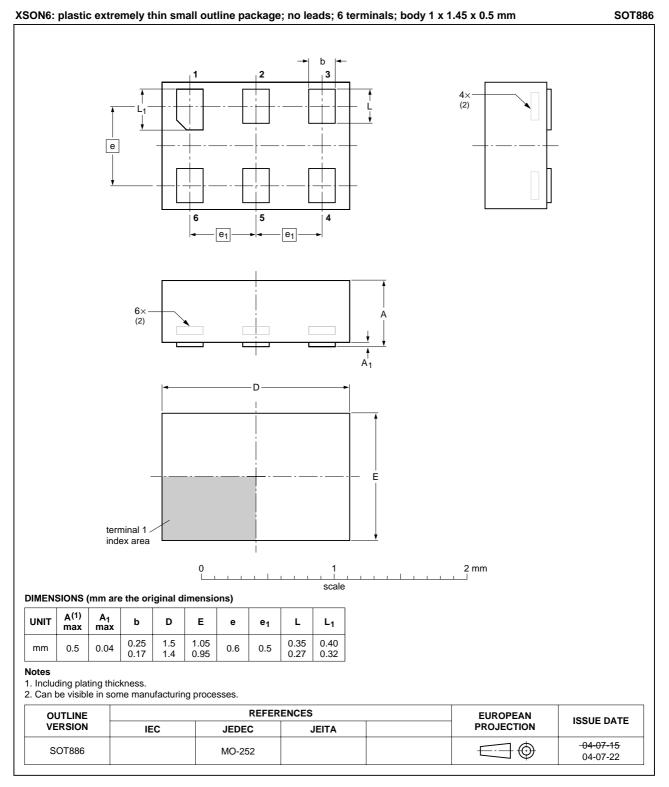


Fig 15. Package outline SOT886 (XSON6)

74AUP1T98_1 Product data sheet

Low-power configurable gate with voltage-level translator

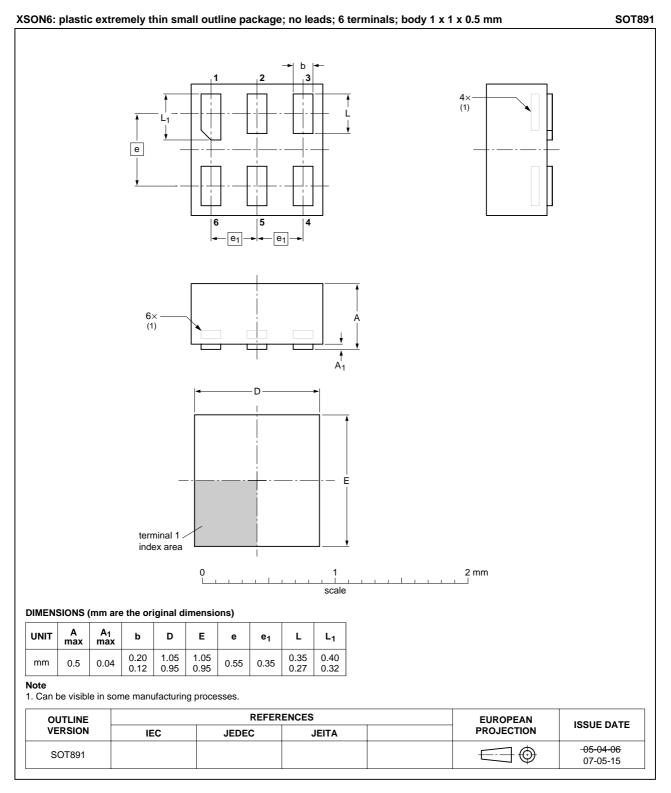


Fig 16. Package outline SOT891 (XSON6)

Low-power configurable gate with voltage-level translator

14. Abbreviations

Table 12.	Abbreviations	
Acronym	Description	
CDM	Charged Device Model	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

15. Revision history

Table 13. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AUP1T98_1	20080306	Product data sheet	-	-	

Low-power configurable gate with voltage-level translator

16. Legal information

16.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

16.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

17. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

74AUP1T98

Low-power configurable gate with voltage-level translator

18. Contents

1	General description 1
2	Features 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 2
6	Pinning information 3
6.1	Pinning
6.2	Pin description 3
7	Functional description 3
7.1	Logic configurations 4
8	Limiting values 5
9	Recommended operating conditions 5
10	Static characteristics 6
11	Dynamic characteristics 8
12	Waveforms 10
13	Package outline 12
14	Abbreviations 15
15	Revision history 15
16	Legal information 16
16.1	Data sheet status 16
16.2	Definitions
16.3	Disclaimers
16.4	Trademarks 16
17	Contact information 16
18	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2008.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 6 March 2008 Document identifier: 74AUP1T98_1

